EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet

Mini TOP View LEDs

65-21SURC/S530-XX/TR8

Features

- White SMT package.
- Optical indicator.
- Wide viewing angle.
- Soldering methods: reflow soldering
- Available on tape and reel

Descriptions

- The 65-21 series is available in soft orange, green, blue, and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes the SMT TOP LED ideal for light pipe application.

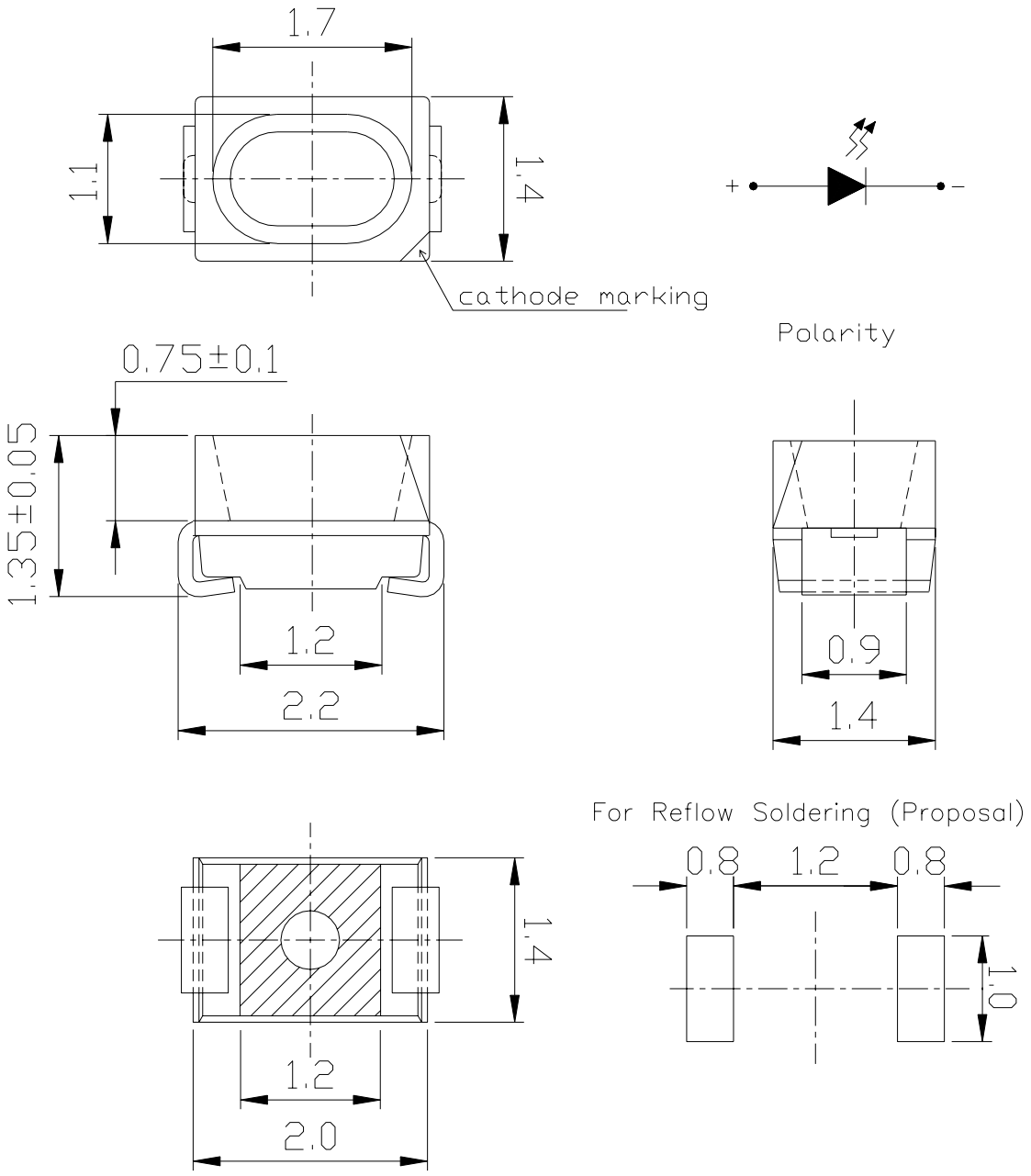
Applications

- Optical indicators.
- Coupling into light guides.
- Backlighting (LCD, cellular phones, switches, keys, displays, illuminated advertising, general lighting).
- Coupling into light guides; Interior automotive lighting (e.g. dashboard backlighting, etc.).

Device Selection Guide

Chip		Lens Color
Material	Emitted Color	
AlGaInP	Hyper Red	Water Clear

Package Outline Dimensions



Notes: All dimensions are in millimeters.
Tolerances unspecified are ±0.1mm.

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	25	mA
Operating Temperature	Topr	-40 ~ +85	℃
Storage Temperature	Tstg	-40 ~ +100	℃
Soldering Temperature	Tsol	260 (for 5 seconds)	℃
Power Dissipation	Pd	60	mW
Electrostatic Discharge	ESD	2000	V
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	60	mA

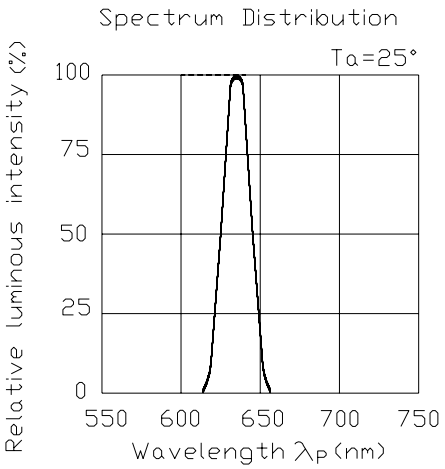
Electro-Optical Characteristics (Ta=25℃)

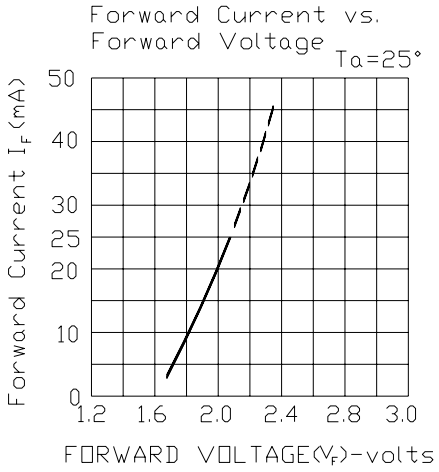
Parameter	Symbol		Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv*	A3	40	68	-----	mcd	I_F=20mA
		A4	50	82	-----		
		A5	63	99	-----		
		A6	80	135	-----		
		A7	100	170	-----		
		A8	125	210	-----		
Viewing Angle	2θ 1/2		-----	120	-----	deg	I_F=20mA
Peak Wavelength	λp		-----	632	-----	nm	I_F=20mA
Dominant Wavelength	λd		-----	624	-----	nm	I_F=20mA
Spectrum Radiation Bandwidth	Δλ		-----	20	-----	nm	I_F=20mA
Forward Voltage	V_F		-----	2.0	2.4	V	I_F=20mA
Reverse Current	I_R		-----	-----	10	μA	V_R=5V

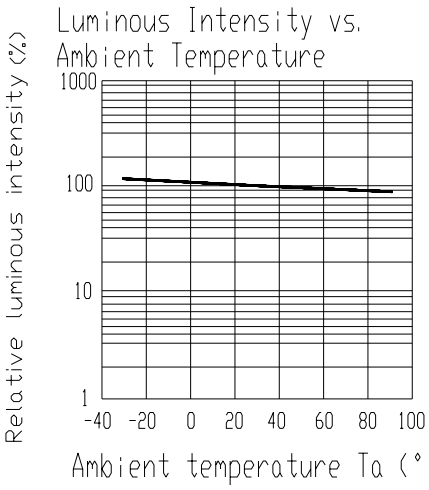
***65-21SURC/S530-XX/TR8**

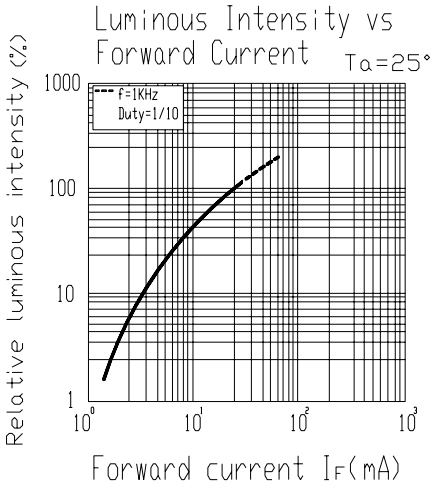
Chip Rank

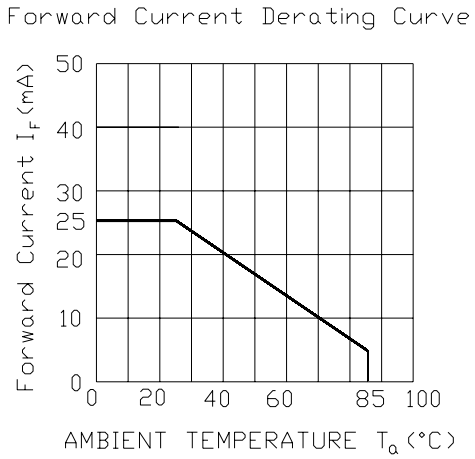
Typical Electro-Optical Characteristics Curves

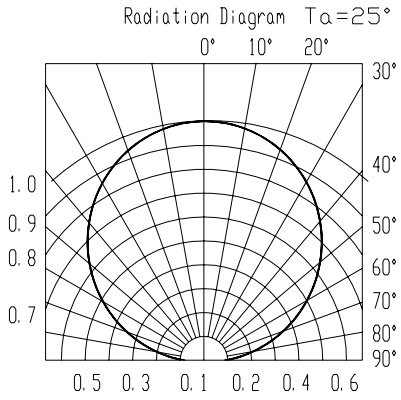












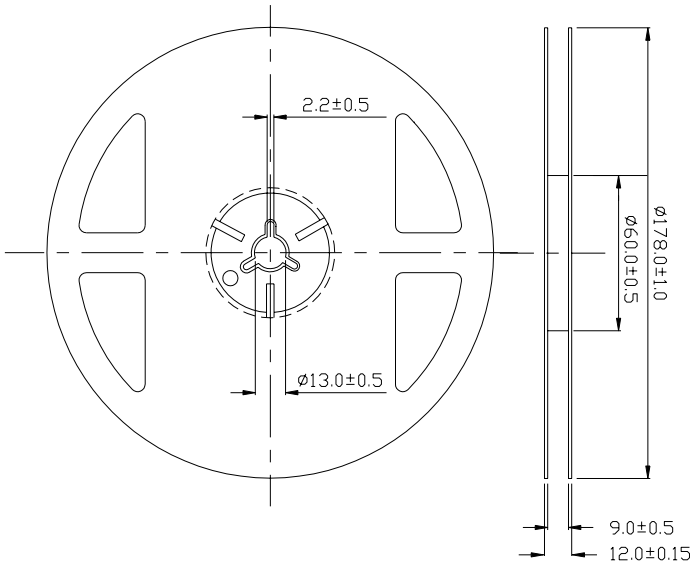
Label explanation

CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank

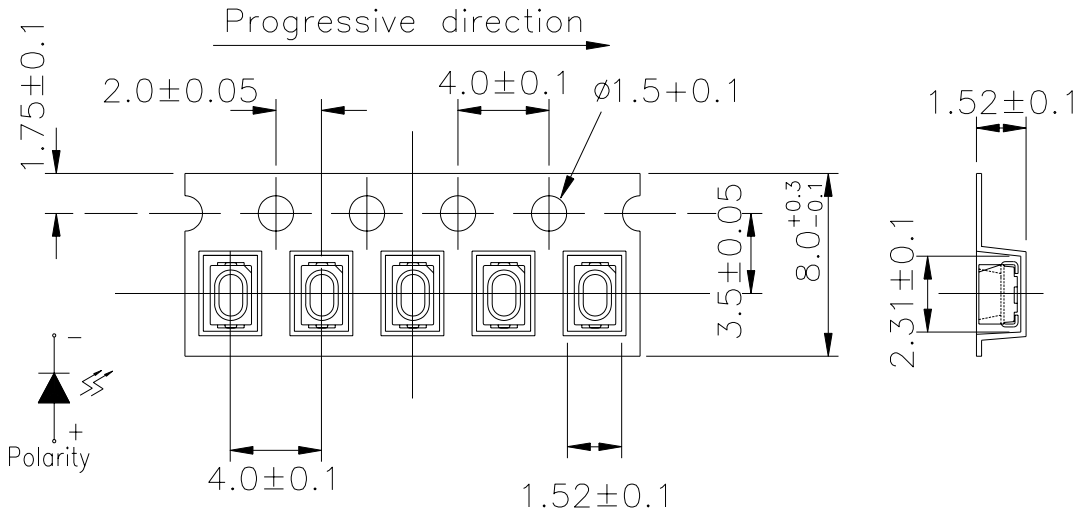
Reel Dimensions



Taping Quantity: 3000pcs

Note: The tolerances unless mentioned is ±0.1mm,Unit = mm

Carrier Tape Dimensions



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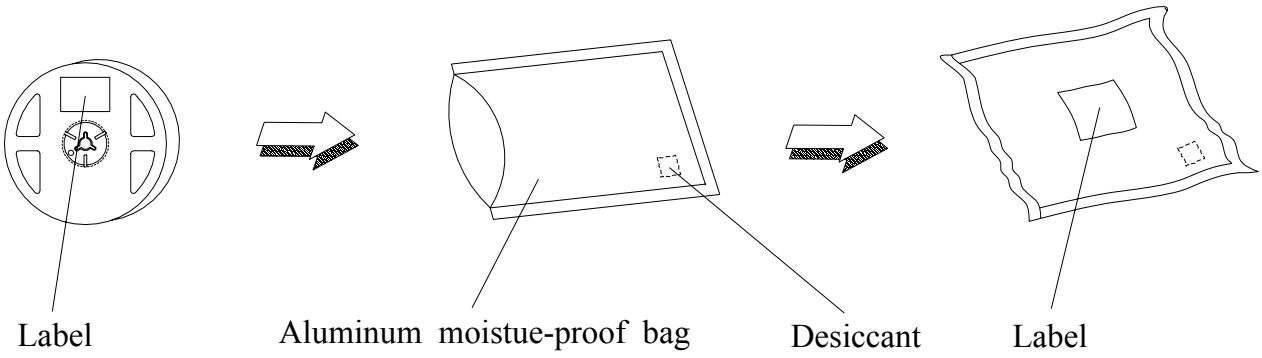
Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.
Confidence level：90%
LTPD：10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Rc
1	Reflow Soldering	Temp. : 240℃±5℃ 5 Sec.	6Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100℃ 15min ∫ 5 min L : -40℃ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100℃ 5min ∫ 10 sec L : -10℃ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I_F = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/RH85%	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

   Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

   2.1 Do not open moisture proof bag before the products are ready to use.

   2.2 Before opening the package, the LEDs should be kept at 30℃ or less and 90%RH or less.

   2.3 The LEDs should be used within a year.

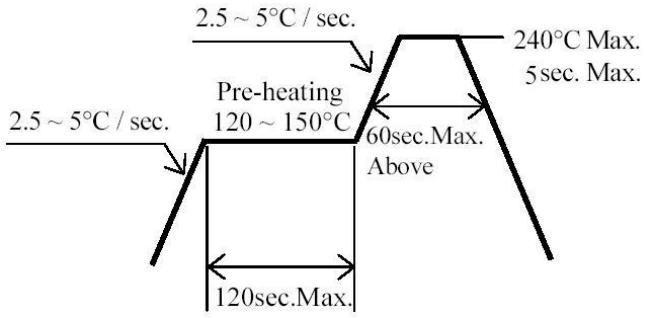
   2.4 After opening the package, the LEDs should be kept at 30℃ or less and 70%RH or less.

   2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

   2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
   Baking treatment : 60±5℃ for 24 hours.

3. Soldering Condition

3.1 Lead solder temperature profile



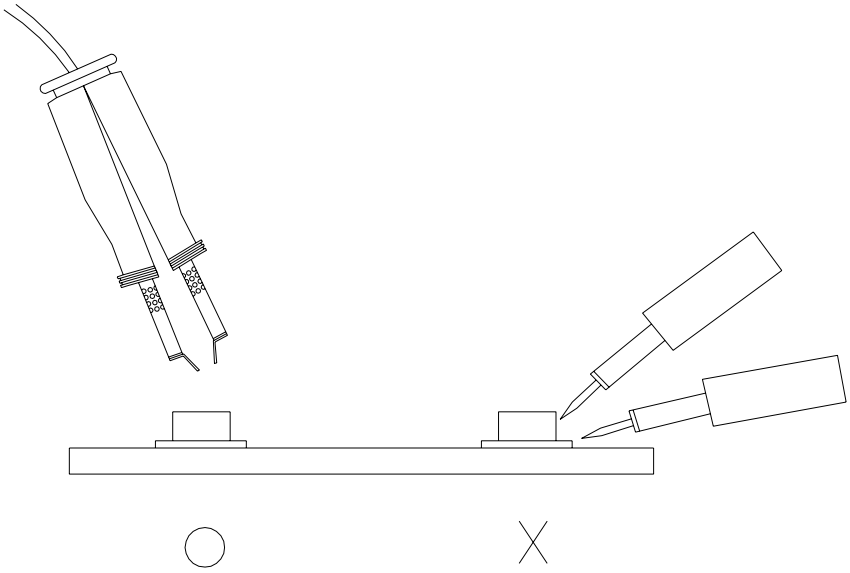
3.2 Reflow soldering should not be done more than two times.
3.3 When soldering, do not put stress on the LEDs during heating.
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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